

RULE 63 (37 C.F.R. 1.63)
COMBINED DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATION
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

FAX RECEIVED

FOR UTILITY/DESIGN
 CIP/PLANT
 ORIGINAL/SUBSTITUTE
 DECLARATIONS

MAY 01 2001

PETITIONS OFFICE

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name, and I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: Semiconductor Memory Device and Method of Manufacturing for Preventing Bit Line Oxidation

the specification of which (CHECK applicable BOX(ES))

☒ is attached hereto

☐ was filed on _____ as U.S. Application No. 08/ _____

☐ was filed as PCT International Application No. PCT/ _____
 on _____

and (if applicable to U.S. or PCT application) was amended on _____

I hereby state that I have reviewed and understand the contents of the above-identified specification, including claims (as amended by any amendment referred to above). I acknowledge the duty to disclose information which is material to the examination of this application in accordance with 37 C.F.R. 1.56(a). I hereby claim foreign priority benefits under 35 U.S.C. 119/365 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate filed by me or my assignee disclosing the subject matter claimed in this application and having a filing date (1) before that of the application on which priority is claimed, or (2) if no priority is claimed, before the filing date of this application:

PRIOR FOREIGN APPLICATION(S)

Priority Claimed

<u>Number</u>	<u>Country</u>	<u>Day/MONTH/Year Filed</u>	<u>YES</u>	<u>NO</u>
97-23917	Korea	10/JUNE/1997	XX	

I hereby claim the benefit under 35 U.S.C. 120/365 of all United States applications listed below and PCT International applications listed above or below and, insofar as the subject matter of each of the claims of this application is not disclosed in such prior applications in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose material information as defined in 37 C.F.R. 1.56(a) which occurred between the filing date of each such prior application and the national or PCT international filing date of this application:

PRIOR U.S. OR PCT APPLICATION(S)

<u>Application No.</u> (series code/serial number)	<u>Day/MONTH/Year Filed</u>	<u>Status</u> pending, abandoned, patented
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or

both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. And I hereby appoint Samsung Electronics Co, Ltd., 1200 New Hampshire Avenue, N.W. Suite 550, Washington, D.C. 20036, telephone number (202) 296-0227 (to whom all communications are to be directed), and the below named attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith and with the resulting patent, and I hereby authorize them to act and rely on instructions from and communicate directly with the person/assignee/attorney/firm/organization who/which first sends/sent this case to them and by whom/which I hereby declare that I have consented after full disclosure to be represented unless/until I instruct Samsung Electronics in writing to the contrary.

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